

BFR380L3

Low profile linear silicon NPN RF bipolar transistor



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Product description

The BFR380L3 is a low noise device based on Si that is part of Infineon's established third generation RF bipolar transistor family. Its high transition frequency and low current and low noise characteristics make the device suitable for a broad range of applications as high as 3.5 GHz. It remains cost competitive without compromising on ease of use.



Feature list

- Minimum noise figure NF_{min} = 1.1 dB at 1.8 GHz, 3 V, 8 mA
- High gain G_{ma} = 14 dB at 1.8 GHz, 3 V, 40 mA
- OIP₃ = 29.5 dBm at 1.8 GHz, 3 V, 40 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC JESD47, JESD22, and J-STD-020. Qualified for industrial applications according to the relevant tests of AEC-Q 101.

Potential applications

- Low noise amplifiers (LNAs) for DVB-T/H
- LNAs for TV white space application
- Low noise, high linearity amplifiers for sub-1 GHz ISM band applications

Device information

Part information Table 1

Product name / Ordering code	Package	Pin cor	nfigurati	ion	Marking	Pieces / Reel
BFR380L3 / BFR380L3E6327XTMA1	TSLP-3-1	1 = B	2 = E	3 = C	FC	15000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25$ °C (unless otherwise specified)

Parameter	Symbol	Symbol Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	_	6	V	Open base
Collector emitter voltage	V _{CES}		15		E-B short circuited
Collector base voltage	V_{CBO}		15		Open emitter
Emitter base voltage	V_{EBO}		2		Open collector
Base current	I _B		14	mA	-
Collector current	I _C		80		
Total power dissipation ¹⁾	P _{tot}		380	mW	<i>T</i> _S ≤ 96 °C
Junction temperature	TJ		150	°C	-
Storage temperature	T_{Stg}	-55			

Attention: Stresses above the max. values listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

 Datasheet
 3
 Revision 3.0

 2024-07-01
 2024-07-01

 $T_{\rm S}$ is the soldering point temperature. $T_{\rm S}$ is measured on the emitter lead at the soldering point of the PCB.



Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Values U		Unit	Note or test condition
		Min.	Тур.	Max.				
Junction - soldering point	R _{thJS}	_	140	_	K/W	-		

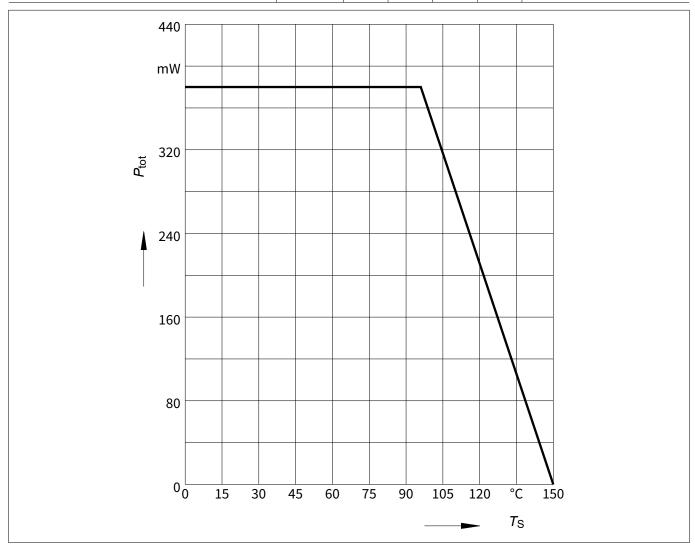


Figure 1 Total power dissipation $P_{\text{tot}} = f(T_S)$

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Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25$ °C (unless otherwise specified)

Parameter	Symbol		Value	s	Unit	Note or test condition	
		Min.	Тур.	Max.			
Collector emitter breakdown voltage	V _{(BR)CEO}	6	9	-	V	$I_C = 1 \text{ mA}, I_B = 0,$ open base	
Collector emitter leakage current	I _{CES}	-	1	30 ²⁾	nA	$V_{CE} = 5 \text{ V}, V_{BE} = 0,$ E-B short circuited	
			_	1000 2)		$V_{CE} = 15 \text{ V}, V_{BE} = 0,$ E-B short circuited	
Collector base leakage current	I _{CBO}			30 ²⁾		$V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0,$ open emitter	
Emitter base leakage current	I _{EBO}		10	500 ²⁾		$V_{\text{EB}} = 1 \text{ V}, I_{\text{C}} = 0,$ open collector	
DC current gain	h _{FE}	90	120	160		$V_{CE} = 3 \text{ V}, I_{C} = 40 \text{ mA},$ pulse measured	

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25$ °C

Parameter	Symbol	Values			Unit	Note or test condition	
		Min.	Тур.	Max.			
Transition frequency	f_{T}	11	14	_	GHz	$V_{CE} = 3 \text{ V}, I_{C} = 40 \text{ mA},$ f = 1 GHz	
Collector base capacitance	C _{CB}	_	0.45	0.8	pF	$V_{CB} = 5 \text{ V}, V_{BE} = 0,$ f = 1 MHz, emitter grounded	
Collector emitter capacitance	C _{CE}		0.18	-		$V_{CE} = 5 \text{ V}, V_{BE} = 0,$ f = 1 MHz, base grounded	
Emitter base capacitance	C _{EB}		1			V _{EB} = 0.5 V, V _{CB} = 0, f = 1 MHz, collector grounded	

Maximum values not limited by the device but by the short cycle time of the 100% test.



Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, T_A = 25 °C.

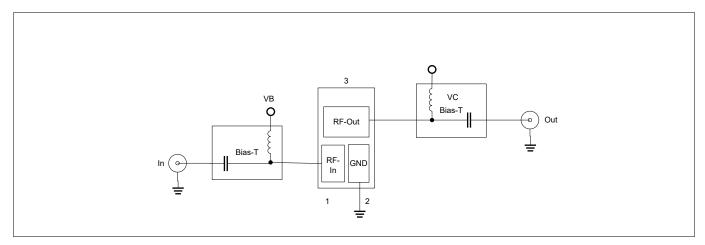


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 1.8 GHz

Parameter	Symbol	Values			Unit	Note or test condition	
		Min.	Тур.	Max.			
Power gain					dB		
Maximum power gain	G _{ma}	11.5	14	16.5		$I_{\rm C} = 40 {\rm mA}$	
• Transducer gain	$ S_{21} ^2$	9.5	11.5	13.5			
Noise figure							
Minimum noise figure	NF _{min}	0.5	1.1	2.1		$I_{\rm C}$ = 8 mA	
Linearity		_		-	dBm	$I_{\rm C}$ = 40 mA,	
3rd order intercept point at output	OIP ₃		29.5			$I_{\rm C} = 40 \text{ mA},$ $Z_{\rm S} = Z_{\rm L} = 50 \Omega,$	
• 1 dB gain compression point at output	OP _{1dB}		16				
	OP _{1dB}		19.5			$Z_{\rm S} = Z_{\rm S,opt}, Z_{\rm L} = Z_{\rm L,opt}$	

Table 7 AC characteristics, $V_{CE} = 3 \text{ V}, f = 3 \text{ GHz}$

Parameter	Symbol	Values		Values Unit		Note or test condition
		Min.	Тур.	Max.		
Power gain					dB	
Maximum power gain	G_{ma}	7.5	10	12.5		$I_{\rm C} = 40 {\rm mA}$
Transducer gain	$ S_{21} ^2$	5.5	7.5	9.5		

Note:

 $G_{\rm ms}$ = $IS_{21}/S_{12}I$ for k < 1; $G_{\rm ma}$ = $IS_{21}/S_{12}I$ (k-(k^2 -1) $^{1/2}$) for k > 1. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP₃ value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 MHz to 6 GHz.



Package information TSLP-3-1

4 Package information TSLP-3-1

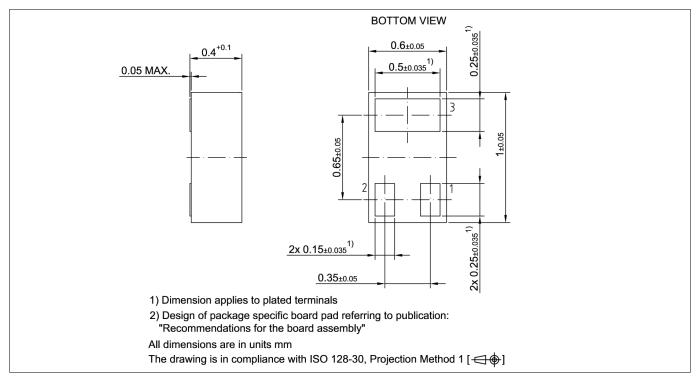


Figure 3 TSLP-3-1 package

Note: For package information including footprint, packing and assembly recommendation refer to:

https://www.infineon.com/packages/TSLP-3-1/

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Revision history

Revision history

Document version	Date of release	Description of changes
Revision 2.0	2019-01-25	New datasheet layout.
Revision 3.0	2024-07-01	Updated product validation

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